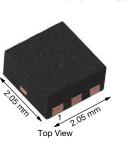
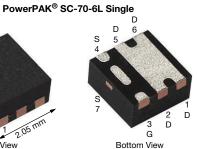
SiA445EDJ

www.vishay.com

Vishay Siliconix





Marking code: BQ

PRODUCT SUMMARY						
V _{DS} (V)	-20					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V	0.0165					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -3.7 V	0.0185					
$R_{DS(on)}$ max. (Ω) at V_{GS} = -2.5 V	0.0300					
Q _g typ. (nC)	23					
I _D (A) ^a	-12					
Configuration	Single					

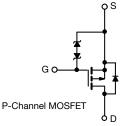
FEATURES

P-Channel 20 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- Thermally enhanced PowerPAK SC-70 package - Small footprint area - Low on-resistance
- 100 % R_a tested
- · Built in ESD protection with Zener diode
- Typical ESD performance: 2000 V
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Smart phones, tablet PCs,
- mobile computing
- Battery switch
- Charger switch
- Load switch



ORDERING INFORMATION	
Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA445EDJ-T1-GE3

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unless	otherwise note	ed)		
PARAMETER		SYMBOL LIMIT		UNIT	
Drain-source voltage		V _{DS}	-20	V	
Gate-source voltage	V _{GS}	± 12	v		
Continuous drain current (T _J = 150 °C)	T _C = 25 °C		-12 ^a		
	T _C = 70 °C		-12 ^a		
	T _A = 25 °C	- I _D -	-11.8 ^{b, c}		
	T _A = 70 °C		-9.5 ^{b, c}	A	
Pulsed drain current (t = 300 µs)		I _{DM}	-50		
Continuous source-drain diode current	T _C = 25 °C	I _S	-12 ^a		
	T _A = 25 °C		-2.9 ^{b, c}		
Maximum power dissipation	T _C = 25 °C		19		
	T _C = 70 °C	Р	12	w	
	T _A = 25 °C	P _D	3.5 ^{b, c}	vv	
	T _A = 70 °C	1	2.2 ^{b, c}		
Operating junction and storage temperature ran	ige	T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature	Ŭ	260	0		

THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, f	t ≤ 5 s	R _{thJA}	28	36	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	5.3	6.5	C/W	

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board

t = 5 s C.

Rework conditions: manual soldering with a soldering iron is not recommended for leadless components e.

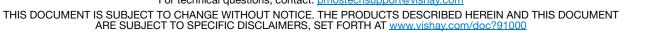
f. Maximum under steady state conditions is 80 °C/W

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For technical questions, contact: pmostechsupport@vishay.com



d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SC-70-6L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = -250 \mu\text{A}$	-20	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-13	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μΑ	-	2.6	-		
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-0.5	-	-1.2	V	
Onte course la classe	1	$V_{DS} = 0 V, V_{GS} = \pm 12 V$	-	-	± 60	-	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$	-	-	± 1		
Zana anto colta da aluaire accurat		$V_{DS} = -20 V, V_{GS} = 0 V$	-	-	-1	μA	
Zero gate voltage drain current	IDSS	V_{DS} = -20 V, V_{GS} = 0 V, T_{J} = 55 °C	-	-	-10		
On-state drain current ^a	I _{D(on)}	$V_{DS} \leq$ -5 V, V_{GS} = -4.5 V	-20	-	-	Α	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -7 \text{ A}$	-	0.0135	0.0165		
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = -3.7 \text{ V}, I_D = -5 \text{ A}$	-	0.0150	0.0185	Ω	
		$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -5 \text{ A}$	-	0.0210	0.0300	1	
Forward transconductance ^a	g _{fs}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -7 \text{ A}$	-	29	-	S	
Dynamic ^b							
Input capacitance	Ciss		-	2130	-	pF	
Output capacitance	C _{oss}	V_{DS} = -10 V, V_{GS} = 0 V, f = 1 MHz	-	290	-		
Reverse transfer capacitance	C _{rss}		-	280	-		
Total and a design		$V_{DS} = -10 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -12 \text{ A}$ $V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -12 \text{ A}$	-	48	72	nC	
Total gate charge	Qg		-	23	35		
Gate-source charge	Q _{gs}		-	3.1	-		
Gate-drain charge	Q _{gd}		-	6.7	-		
Gate resistance	R _g	f = 1 MHz	1.2	6	12	Ω	
Turn-on delay time	t _{d(on)}		-	25	50	-	
Rise time	tr	V_{DD} = -10 V, R_L = 1 Ω	-	25	50		
Turn-off delay time	t _{d(off)}	$I_D\cong$ -9.5 Å, V_{GEN} = -4.5 V, R_g = 1 Ω	-	55	110		
Fall time	t _f		-	20	40		
Turn-on delay time	t _{d(on)}		-	7	15	ns	
Rise time	t _r	V_{DD} = -10 V, R_L = 1 Ω	-	10	20	-	
Turn-off delay time	t _{d(off)}	$I_D \cong -9.5 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	60	120		
Fall time	t _f		-	17	35		
Drain-Source Body Diode Characterist	ics		•				
Continuous source-drain diode current	ا _S	T _C = 25 °C	-	-	-12	^	
Pulse diode forward current	I _{SM}	M		-	-50	A	
Body diode voltage	V _{SD}	$I_{\rm S}$ = -9.5 A, $V_{\rm GS}$ = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t _{rr}		-	15	30	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = -9.5 A, di/dt = 100 A/μs,	-	5	10	nC	
Reverse recovery fall time	ta	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	-	7	-		
Reverse recovery rise time	t _b		-	8	-	ns	

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

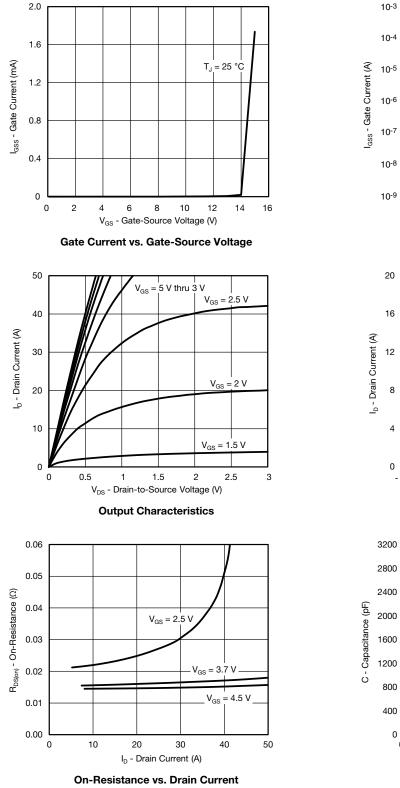
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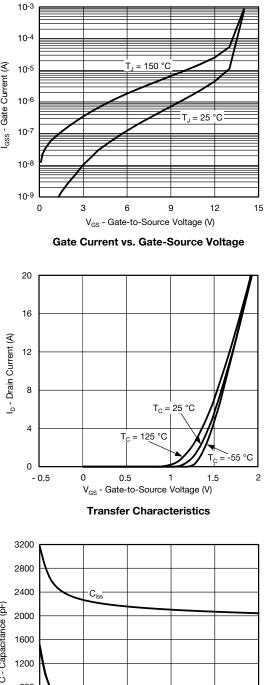
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





V_{DS} - Drain-to-Source Voltage (V) Capacitance

12

16

8

Crss

4

0

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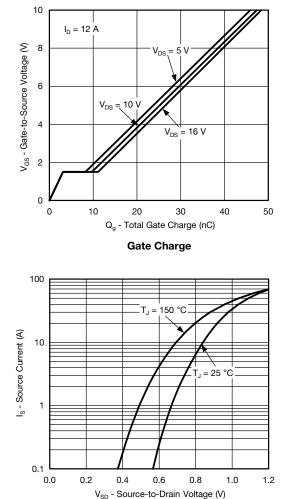
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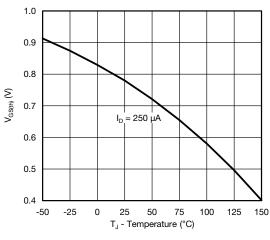


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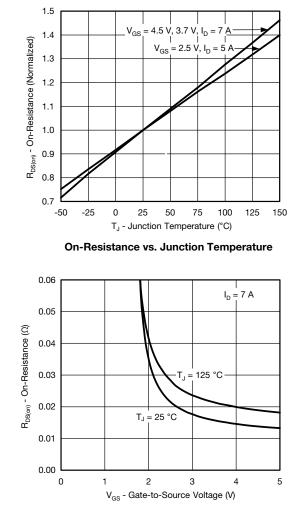
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



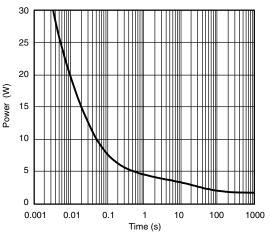
Source-Drain Diode Forward Voltage



Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

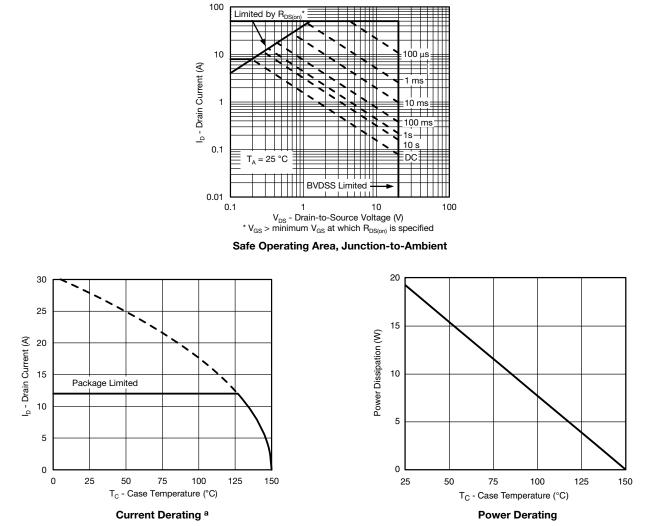
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Note

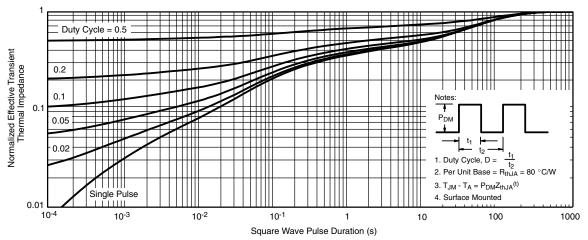
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



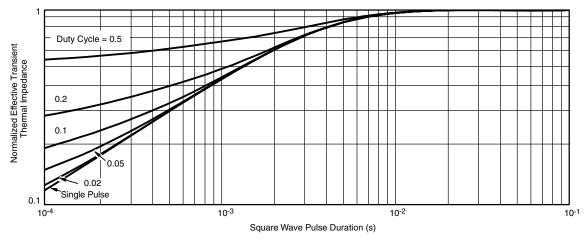
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63619.



PowerPAK[®] SC70-6L

VISHA

b PIN2 PIN1 PIN3 _ ₹



b

PIN3

__ ₿

PIN2

PIN1

¥

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¹



RECOMMENDED PAD LAYOUT FOR PowerPAK[®] SC70-6L Single



Dimensions in mm/(Inches)

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